

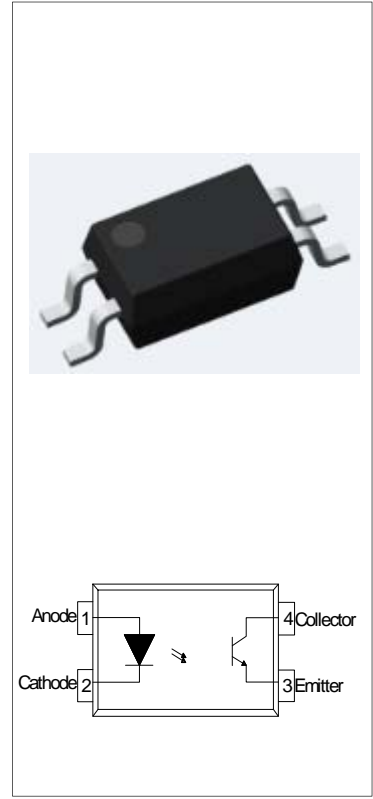


## JOCT217X-S4 Series

Rev.A.1.0

### DESCRIPTION:

The products are transistor opto-couplers in a SSOP4 package. The device is a photoelectric coupler composed of light-emitting diode and phototransistor. The products are widely used in switching power supply, intelligent meter, industrial control, measuring instruments, office equipment such as copiers, household appliances: such as air conditioners, fans, water heaters, etc.



### MAIN FEATURES

- High isolation 3750 VRMS
- Operating temperature range -55°C to 110°C
- RoHS & REACH Compliance
- HBM: H3A; MM: M4; CDM:C3
- CQC approved
- VDE approved
- UL approved

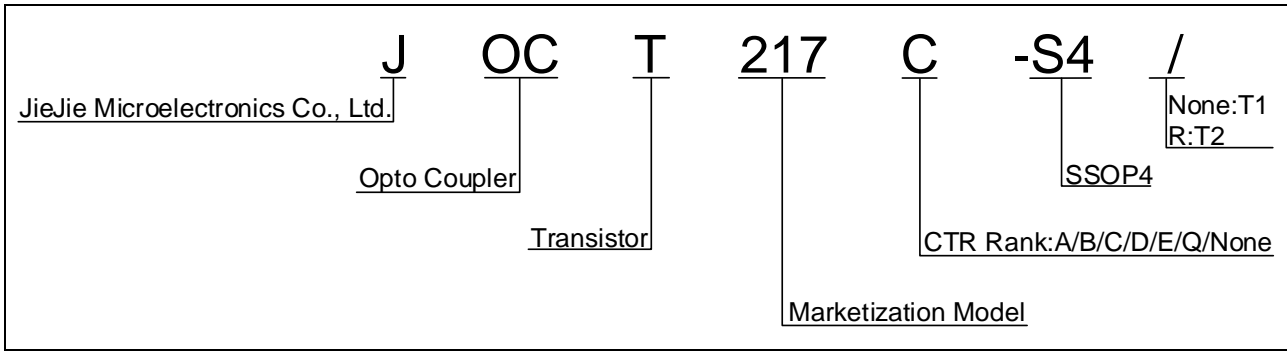
### ABSOLUTE MAXIMUM RATINGS (Temperature=25°C)

Parameter		Symbol	Value	Unit
Input	Forward Current	$I_F$	50	mA
	Peak Forward Current	$I_{FP}$	1 <sup>7</sup>	A
	Reverse Voltage	$V_R$	6	V
	Power Dissipation	$P_D$	75	mW
Output	Collector-emitter Voltage	$V_{CEO}$	80	V
	Emitter-collector Voltage	$V_{ECO}$	7	V
	Collector Current	$I_C$	50	mA
	Power Dissipation	$P_C$	150	mW
Total Power Dissipation		$P_{tot}$	2	mW
Isolation Voltage		$V_{iso}$	3750 <sup>8</sup>	Vrms
Operating Temperature		$T_{opr}$	-55~+110	
Junction Temperature		$T_j$	125	

Storage Temperature	T <sub>stg</sub>	-55~+125	
Soldering Temperature	T <sub>sol</sub>	260	

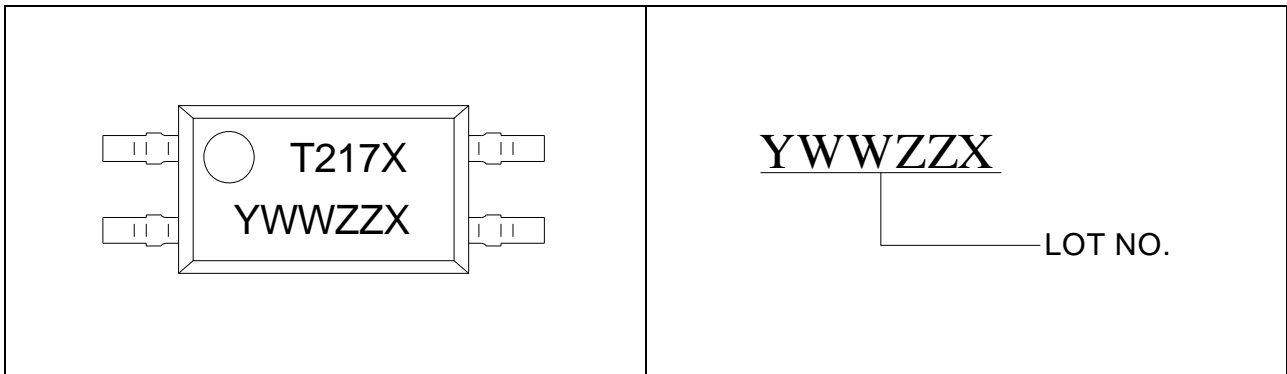
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ORDERING INFORMATION



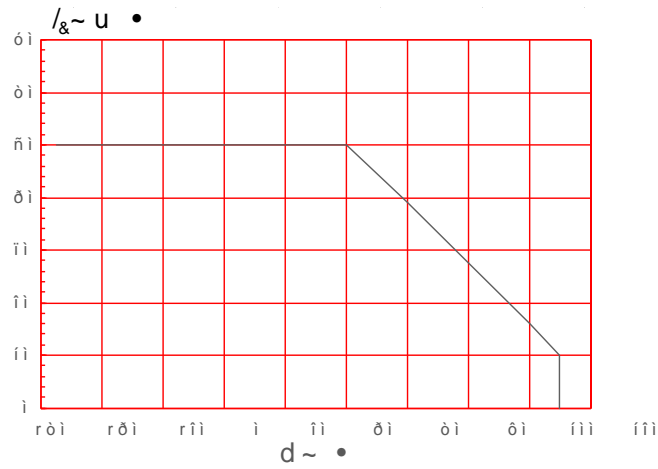
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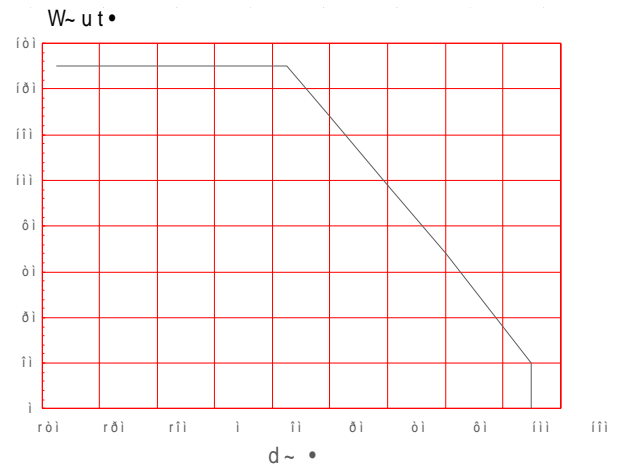
Characteristics Curves

**FIG.1:** Max. Allowable LED Forward Current vs. Ambient Temperature



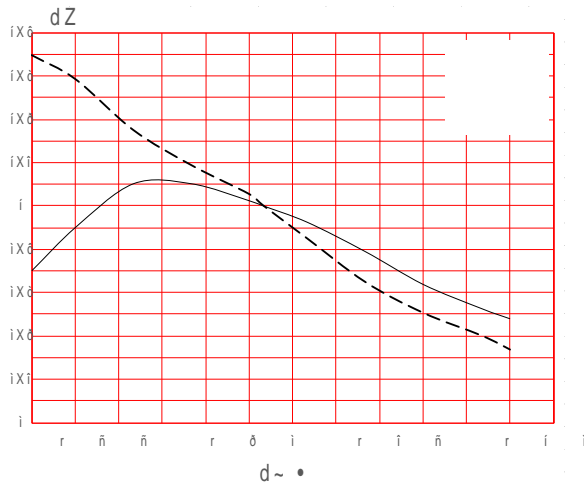
**FIG.3:** Forward Current vs. Forward Voltage

**FIG.2:** Collector Power Dissipation vs. Ambient Temperature



**FIG.4:** Normalized Collector Dark Current

**FIG.7:** Normalized Current Transfer Ratio vs. Ambient Temperature



**FIG.8:** Normalized Collector-emitter Saturation Voltage vs. Ambient Temperature

Test Circuits

FIG.11: Test Circuits of Response Time

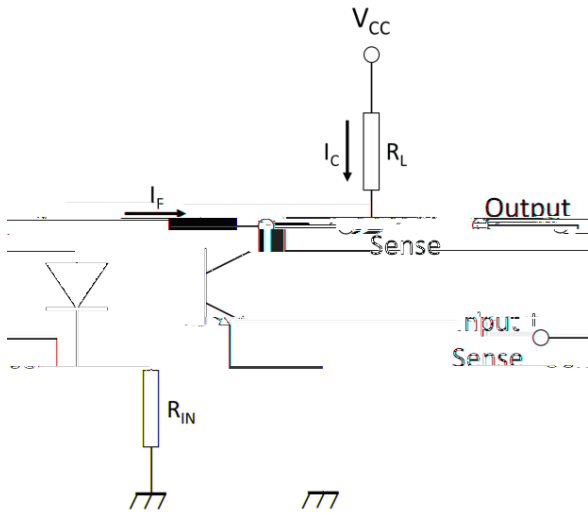


FIG.12: Curves of Response Time

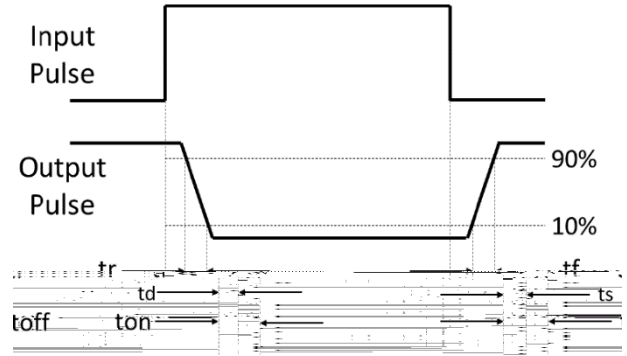
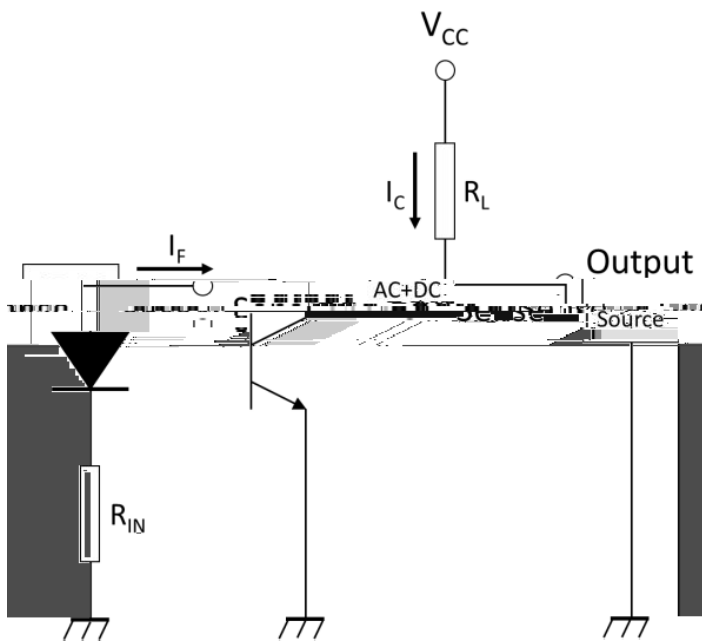
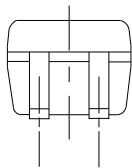
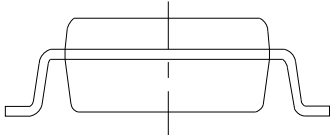
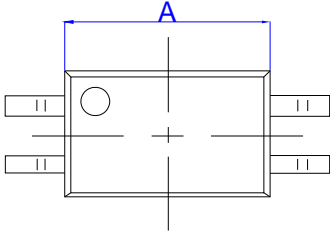


FIG.13: Test Circuits of Frequency Response

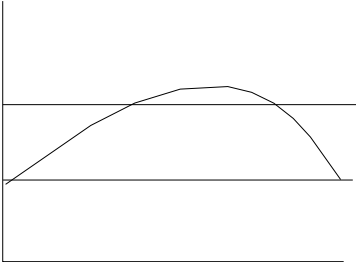


Package Dimension (Unit: mm)





REFLOW INFORMATION



Note:

1. Reflow soldering is recommended at the temperatures and times shown, no more than three times.
2. Avoid direct contact be